

2.0X1.25mm SMD CHIP LED LAMP

APTK2012TGC

GREEN

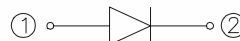
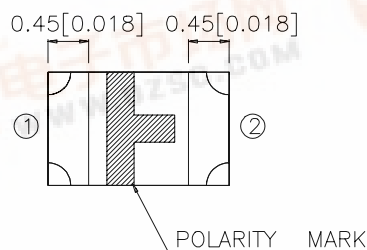
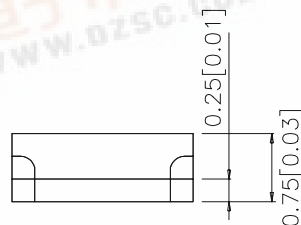
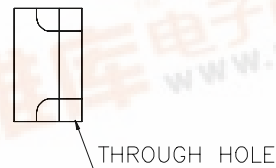
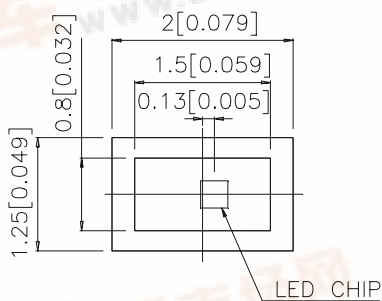
Features

- 2.0mmX1.25mm SMT LED, 0.75mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 2000PCS / REEL.

Description

The Green source color devices are made with InGaN on SiC Light Emitting Diode.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.1 (0.004") unless otherwise noted.
3. Specifications are subject to change without notice.



Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 20 mA		Viewing Angle
			Min.	Typ.	2θ1/2
APTK2012TGC	GREEN(InGaN)	WATER CLEAR	70	150	100°

Note:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Electrical / Optical Characteristics at T_A=25°C

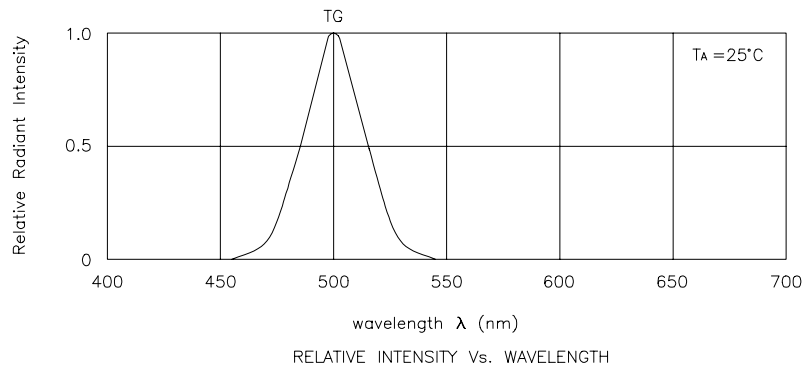
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ _{peak}	Peak Wavelength	Green	500		nm	I _F =20mA
λ _D	Dominate Wavelength	Green	505		nm	I _F =20mA
Δλ _{1/2}	Spectral Line Half-width	Green	30		nm	I _F =20mA
C	Capacitance	Green	56		pF	V _F =0V;f=1MHz
V _F	Forward Voltage	Green	3.6	4.4	V	I _F =20mA
I _R	Reverse Current	Green		10	uA	V _R = 5V

Absolute Maximum Ratings at T_A=25°C

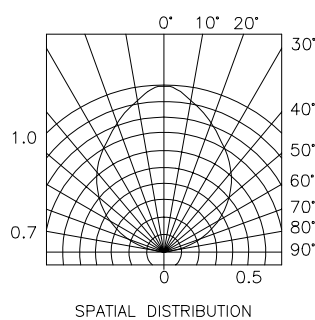
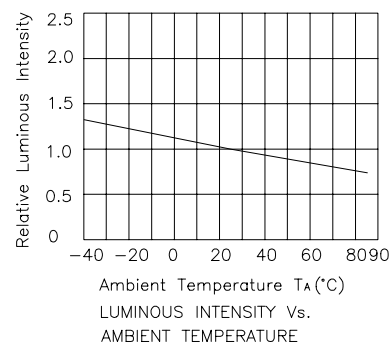
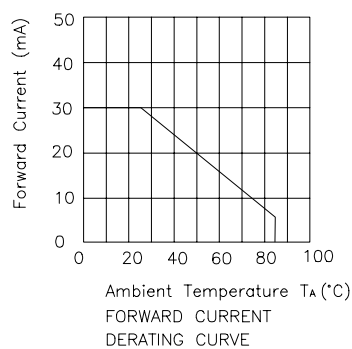
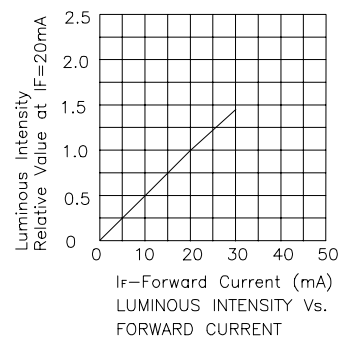
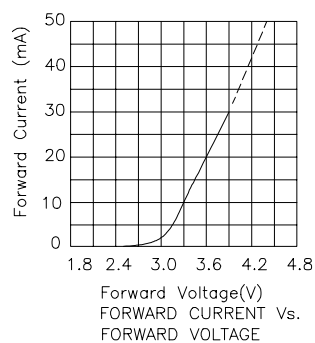
Parameter	Green	Units
Power dissipation	110	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



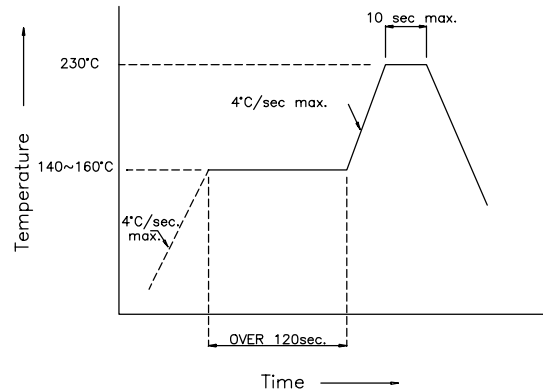
Green APTK2012TGC



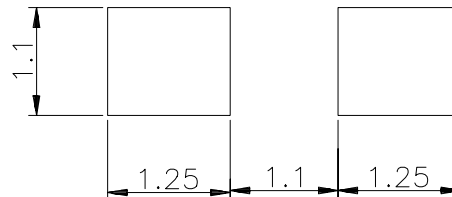
APTK2012TGC

SMT Reflow Soldering Instructions

Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units : mm)



Tape Specifications (Units : mm)

